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(21)Application number : 2000-126945 (71)Applicant : NIPPON MINING & METALS CO LTD
(22)Date of filing : 27.04.2000 (72)Inventor : YAMAMOTO MICHIHARU

(54) COPPER ALLOY MALLEABLE MATERIAL EXCELLENT IN BENDING WORKABILITY AND METHOD FOR PRODUCING COPPER ALLOY MALLEABLE MATERIAL

(57)Abstract:

PROBLEM TO BE SOLVED: To produce a copper alloy malleable material small in anisotropy and excellent in bending workability.

SOLUTION: The difference in tensile strength between the rolling parallel direction and the rolling vertical direction is ≤ 30 N/mm².

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(54)【発明の名称】 曲げ加工性が優れた銅合金展伸材及び銅合金展伸材の製造法

(57)【要約】

【課題】 異方性が少なく曲げ加工性が優れた銅合金展伸材を提供する。

【解決手段】 圧延平行方向と圧延垂直方向の引張り強さの差が30N/mm²以下である。

【特許請求の範囲】

【請求項1】チタンを0.5質量%以上5.0質量%未満含み、残部実質的になる銅及び不可避不純物からなる銅合金に圧延、溶体化処理及び時効処理を施して製造され、最終溶体化処理後の結晶粒度が0.005 μm 以上0.035 μm 未満であり、時効処理後800N/mm²以上の引張り強さを有し、圧延平行方向と圧延垂直方向の引張り強さの差で表される異方性が30N/mm²以下と少なく、曲げ加工性が優れたことを特徴とする銅合金展伸材。

【請求項2】チタンを0.5質量%以上5.0質量%未満含み、残部が実質的銅及び不可避不純物からなる銅合金錫塊に圧延、溶体化処理及び時効処理を施して展伸材を製造するに際して、該銅合金の最終溶体化処理後の結晶粒度を0.005mm以上0.035 μm 未満にすることを特徴とする銅合金展伸材の製造法。

【請求項3】上記銅合金を連続熱処理設備にて溶体化処理を行う場合、最終溶体化処理の条件を、加熱温度が923K(650°C)以上1123K(850°C)未満で10秒以上300秒未満に加熱した後、200K/秒以上の冷却速度で急冷することを特徴とする請求項2記載の銅合金展伸材の製造法。

【発明の詳細な説明】

【0001】

【発明の属する技術分野】本発明は、チタンを0.5質量%以上5.0質量%未満含み、残部銅及び不可避不純物からなる銅合金展伸材、及び錫塊に圧延、溶体化処理及び時効処理を施して銅合金展伸材を製造する方法に係り、更に詳しく述べるならば、異方性が少なくかつ曲げ加工性の優れた銅合金展伸材を提供するものである。

【0002】

【従来の技術】チタンを含んだ銅合金（以下「チタン銅合金」と言う）は、時効析出型の銅合金として材料特性の中でも特に強度及び応力緩和特性が優れているため、電子部品や端子・コネクター部品の分野において広く使用されてきている。該銅合金は、溶解錫塊によって錫塊を製造すると、その後に熱間及び冷間加工、熱処理などの加工が施され、一部の材料については更にめっき等の表面処理を施されて、所定の特性及び形状にした後、部品に加工される。チタン銅合金に含まれるチタンは過飽和固溶体から分離され、Cu-Ti相への中間相生成によって時効硬化を起こすものと考えられている。上記特性のほかにチタン銅合金は耐熱性が高力ベリウム銅と比べて優れていることも特長である。従って、板・条材に打ち抜き加工や曲げ加工を施して電子部品や端子・コネクター材料として広く使用されている。

【0003】一方、展伸材を製造する際には、特に溶体化処理や時効処理条件によって、その後の加工性や材料特性が大きく異なる。溶体化処理では、その条件によって過飽和固溶体からの析出は核生成を必要としないスピノーダル分解が生じ、特性が大きく変化する。スピノ-

ダル分解は、材料内部に存在する溶質濃度のゆらぎが生じると、系の自由エネルギーは過飽和固溶体としてのエネルギーよりも低く、相分解は自発的に進行して臨界核を形成しない。すなわち、材料内に一旦小さい濃度変動が生ずれば、次々に大きな濃度変動に変化していき最終的には2相に分離する。スピノーダル分解が起こると材料特性が大きく変化するが、この分解は急速に進行する。

【0004】従って、熱間圧延や溶体化処理を行った後にスピノーダル分解が生じる前に材料を冷却しておくことが出来れば、その後の加工が容易になるばかりでなく、材料特性ばらつきが小さくなれば品質が安定するため、チタン銅合金の溶体化処理に関して、特性のばらつきが小さく、かつその後の加工が容易になる冷却条件で処理することは必要となる。また、チタン銅合金を時効処理した後に部品加工する際に異方性を少なくして曲げ加工性を向上させる必要がある。

【0005】

【発明が解決しようとする問題点】しかしながら、従来は異方性に及ぼす製造工程条件のうちどの因子が最も影響が大きいかが把握されていなかったので、曲げ加工性は不充分であった。本発明者らの研究と実験によると、溶体化処理冷却条件及び溶体化処理による材料の結晶粒度がその後の材料特性に大きく影響を及ぼしていることが判明した。本発明は係る点に鑑みて為されたものであり、異方性を少なくして部品加工の際の曲げ加工性の優れた銅合金展伸材を提供するものである。

【0006】

【課題を解決するための手段】本発明の要旨とするところは次の如くである。

(1) チタンを0.5質量%以上5.0質量%未満含み、残部実質的銅及び不可避不純物からなる銅合金に圧延、溶体化処理及び時効処理を施して製造され、最終溶体化処理後の結晶粒度が0.005 μm 以上0.035 μm 未満であり、時効処理後800N/mm²以上の引張り強さを有し、圧延平行方向と圧延垂直方向の引張り強さの差で表される異方性が30N/mm²以下と少なく、曲げ加工性が優れたことを特徴とする銅合金展伸材。

(2) チタンを0.5質量%以上5.0質量%未満含み、残部が実質的銅及び不可避不純物からなる銅合金錫塊に圧延、溶体化処理及び時効処理を施して展伸材を製造するに際して、銅合金の最終溶体化処理後の結晶粒度を0.005mm以上0.035 μm 未満にすることを特徴とする銅合金展伸材の製造法。

(3) 上記銅合金を連続設備にて溶体化処理を行う場合、最終溶体化処理の条件を加熱温度が923K(650°C)以上1123K(850°C)未満で10秒以上300秒未満に加熱した後、200K/秒以上の冷却速度で急冷することを特徴とする銅合金展伸材の製造法。

【0007】すなわち、上述のように、チタンを0.5質

量%以上5.0質量%未満含み、残部銅及び不可避不純物からなる銅合金展転伸材において時効処理後の引張り強さが800N/mm²未満であると、強度が不足し、また圧延平行方向と圧延垂直方向の引張り強さの差で表される異方性が30N/mm²を超えると、異方性が大きくなり、曲げ加工性が優れないために、本発明においては、時効処理後800N/mm²以上の引張り強さを有し、圧延平行方向と圧延垂直方向の引張り強さの差で表される異方性が30N/mm²以下と限定した。かかる優れた展伸材の等方性と高強度は、従来材では得られないものであり、これは中間工程の結晶粒度（最終溶体化処理後の結晶粒度）と関係している。なお、最終的結晶粒度は、後工程の処理の影響によって、中間工程の結晶粒度に対し多少増減するが、異方性には重大な影響を及ぼさない。

【0008】次に、本発明において、チタンを0.5質量%以上5.0質量%未満を含み、残部実質的に銅及び不可避不純物としたのは、チタンの添加量が0.5質量%未満になると強度など優れた特性が得られず、5.0質量%以上になると材料が硬化して加工性の優れた材料が得られないためである。なお、チタンに加えて、総量で1.0質量%以下のクロム、ジルコニウム、ニッケル、鉄などを添加しても同様の効果を期待することができる。該銅合金の最終溶体化処理後の結晶粒度を5μm以上35μm未満としたのは、結晶粒度が0.005μm未満になると、冷間加工などの前加工の影響が残存して、十分な加工特性をもつ展伸材が得られないためであり、該結晶粒度が0.035μm以上になると部品加工する際に異方性が大きくなり、曲げ加工性が著しく劣るためである。

【0009】また、連続熱処理設備を用いて溶体化処理を行う場合は、最終溶体化処理の条件を、加熱温度が923K(650°C)以上1123K(850°C)未満で10秒以上300秒未満に加熱した後、200K/秒以上の冷却速度で急冷することが好ましい。加熱温度が923K(650°C)未満であると、300秒以上の加熱でも上記結晶粒度が得られず、1123K(850°C)以上であると、その温度に達すると直ちに粒成長して上記結晶粒度の材料を得るために制御が困難になる。更に、溶体化処理後の冷却速度を200K/秒以上としたのは、200K/秒未満の冷却速度で冷却すると、冷却時にスピノーダル分解が生じて材料が硬化するためである。なお、200K/秒以上の冷却速度を達成するには、水冷若しくは気水噴霧による冷却によって得られる。

【0010】

【作用】本発明によれば、チタン銅合金の最終溶体化処理後の結晶粒度を0.005μm以上0.035μm未満にすると、部品加工した際の異方性を少なくし、曲げ加工性の優れた特性を有する材料を提供することが可能となる。

【0011】

【実施例】供試材として用いたチタンを所定質量%含有したチタン銅合金の成分を表1に示す。所定の成分に配

合されたチタン銅合金の鋳塊3.5kg(30mm×120mm×100mm)を真空溶解炉内で溶製し、押し湯部を切断した後に表面皮むきを行う。皮むきされた鋳塊は、大気中で1123K(850°C)で1時間均質化焼純を行った後に27mm厚から所定の厚さ（通常は8mm厚）まで熱間圧延を行う。圧延中は2色式輻射温度計で材料表面温度を測定し、所定の温度になったところで水冷した。

【0012】

【表1】

試験に用いたチタンを所定質量%含有した銅合金の成分

	成分(wt%)	
	Ti	銅
1 チタン銅①	1.5	残
2 チタン銅②	3.0	残
3 チタン銅③	4.5	残
比較		
4 チタン銅④	0.4	残
5 チタン銅⑤	6.0	残

【0013】比較合金であるチタン銅④は、最終時効処理まで行ったが、必要とされる特性（引張り強さ800N/mm²、伸び2%以上）が得られなかった。比較合金であるチタン銅⑤は、熱間圧延の際に割れが発生し、その後の加工が困難になった。

【0014】更に、1173K(900°C)で1時間溶体化処理をした後に、再度表面皮削りを行い、冷間圧延にて7.5mm厚から1.0mm厚にする。次に、加熱・冷却速度を任意に変更できる装置を用いて所定の温度で所定時間加熱し、種々の冷却条件で冷却する最終溶体化処理を行い、その後に伸銅品の結晶粒度試験方法(JIS H0501)に従って評価した。更に材料厚さ0.3mmまで冷間圧延を施して、673K(400°C)で4時間時効処理を施した。なお、熱処理中の材料温度は接触式の熱電対を材料の熱処理部分に装着して試験中の材料温度を連続的に測定し、種々の冷却速度は水冷、汽水噴霧、空冷の水量、ガス流量を調整することによって行った。その後、材料の圧延に平行及び垂直方向の引張り試験を行って異方性を調査すると共にくり返し曲げ試験によって曲げ性を評価した。

【0015】図1(表2)には、供試材の最終熱処理条件を示す。また、図2(表3)には、引張り試験及び繰り返し曲げ試験を行った試験結果を示す。引張り試験はN=3の平均値を示す。90°繰り返し曲げ試験は、曲げ半径R=0.3mmで(板厚0.3mm)破断までの回数で評価した。表中の“破断”は1回目の曲げ加工で破断した。表3より明らかなように、本発明にて製造した方法によって、異方性が小さく、また繰り返し曲げ性も優れた該銅合金を製造することが可能となった。

【発明の効果】本発明によれば、異方性が小さく、また繰り返し曲げ性も優れた該銅合金を製造することが可能となる。

【図面の簡単な説明】

【図1】供試材の最終熱処理条件を示す図表(表2)である。

【図2】引張り試験及び繰り返し曲げ試験を行った試験結果を示す図表(表3)である。

【図1】

表2 供試材の最終熱処理条件

		加熱温度 K (°C)	加熱時間 (秒)	急冷時の冷却速度 (K/秒)	溶体化処理後の 結晶粒度(μm)
1	チタン銅 ①	1023(750)	20	1000	10
2	チタン銅 ①	973(700)	120	800	10
3	チタン銅 ②	1073(800)	100	1000	20
4	チタン銅 ②	1073(800)	15	1000	10
5	チタン銅 ②	1073(800)	120	1000	30
6	チタン銅 ②	1023(750)	30	800	10
7	チタン銅 ②	953(680)	250	800	10
8	チタン銅 ③	1073(800)	60	800	20
9	チタン銅 ③	1023(750)	100	1000	20
10	チタン銅 ③	953(680)	250	800	10
比較					
10	チタン銅 ①	873(600)	250	1000	5<
11	チタン銅 ②	893(620)	250	800	5<
13	チタン銅 ②	1173(900)	100	1000	40
14	チタン銅 ②	973(700)	10	1000	5<
15	チタン銅 ③	1073(800)	600	800	40

【図2】

表3 引っ張り試験及び繰り返し曲げ試験

	溶体化処理 後の結晶粒 度 (μm)	引張強さ (N/mm ²)		90° 繰り返し曲げ (回)	
		平行方向	垂直方向	平行方向	垂直方向
1	チタン銅 ①	10	870	890	3
2	チタン銅 ①	10	920	930	3
3	チタン銅 ②	20	900	910	4
4	チタン銅 ②	10	910	920	3
5	チタン銅 ②	30	880	900	4
6	チタン銅 ②	10	960	970	3
7	チタン銅 ②	10	920	940	3
8	チタン銅 ③	20	980	1000	3
9	チタン銅 ③	20	1000	1030	1
10	チタン銅 ③	10	1050	1070	1
比較					
10	チタン銅 ①	5<	920	970	1
11	チタン銅 ②	5<	970	1030	1
13	チタン銅 ②	40	880	920	2
14	チタン銅 ②	5<	1000	1050	破断
15	チタン銅 ③	40	950	1020	1

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Notes:

1. Untranslatable words are replaced with asterisks (****).
2. Texts in the figures are not translated and shown as it is.

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FULL CONTENTS

[Claim(s)]

[Claim 1] Titanium is rolled to the copper alloy which consists of copper as for which more than 0.5 mass % becomes a under 5.0 mass % implication and a remainder real target, and an inevitable impurity. Solution treatment and aging treatment are performed, it is manufactured, and the grain size number after the last solution treatment of more than 0.005 mm is under 0.035 mm. Copper alloy expansion material characterized by for there having been little anisotropy which has the tensile strength of 800Ns/mm² or more after aging treatment, and is expressed with the difference of the tensile strength of a rolling parallel direction and a rolling perpendicular direction in mm² and 30Ns /or less, and bending nature being excellent.

[Claim 2] It faces performing rolling, solution treatment, and aging treatment to the copper alloy ingot which a under 5.0 mass % implication and the remainder become from copper and an inevitable impurity substantially about titanium in more than 0.5 mass %, and manufacturing expansion material. The manufacturing method of the copper alloy expansion material characterized by making the grain size number after the last solution treatment of this copper alloy under into 0.005mm or more 0.035 mm.

[Claim 3] When continuation heat treatment equipment performs solution treatment, the above-mentioned copper alloy [the conditions of the last solution treatment] The manufacturing method of the copper alloy expansion material according to claim 2 characterized by quenching with the cooling rate more than a 200K/second after cooking temperature heats 10 seconds or more under by 1123K (850 degrees C) more than 923K (650 degrees C) at less than 300 seconds.

[Detailed Description of the Invention]

[0001]

[Field of the Invention] The copper alloy expansion material which, as for this invention, more than 0.5 mass % becomes from a under 5.0 mass % implication, remainder copper, and an inevitable impurity about titanium, And if the method of performing rolling, solution treatment, and aging treatment to an ingot, and manufacturing copper alloy expansion material is started and it states in more detail, anisotropy offers the copper alloy expansion material which was excellent in bending nature few.

[0002]

[Description of the Prior Art] Since hardness and a stress relaxation characteristic are excellent also especially in the material property as a copper alloy of an aging precipitation type, the copper alloy (henceforth a "titanium copper alloy") having contained titanium has been widely used in the field of electronic parts, or a terminal and a connector area article. If an ingot is manufactured by dissolution casting, after performing processing of between heat and cold working, heat treatment, etc. after that, performing surface preparation, such as metal plating, to this copper alloy further about some ingredients and making it into predetermined characteristics and a predetermined configuration, it is processed into components. The titanium contained in a titanium copper alloy is separated from a supersaturated solid solution, and it is thought that age-hardening is started by intermediate phase generation to a Cu₃Ti phase. It is the feature that the titanium copper alloy other than the above-mentioned characteristics is also excellent in a heat-resisting property compared with high tensile beryllium copper. Therefore, it pierces to a plate and a bar, processing and bending are performed, and it is widely used as electronic parts, or a terminal and a connector ingredient.

[0003] On the other hand, especially when manufacturing expansion material, subsequent workability and a subsequent material property change greatly with solution treatment or aging treatment conditions. In solution treatment, the spinodal decomposition which does not need a nucleation produces the deposit from a supersaturated solid solution, and characteristics change with the conditions a lot. If the fluctuation of the solute concentration which exists in the core of an ingredient produces spinodal decomposition, the free energy of a system is lower than the energy as a supersaturated solid solution, and phase decomposition will advance spontaneously and will not form the nucleus of critical size. That is, once a small concentration change arises in an ingredient, it will change to a big concentration change one after another, and will separate into two phases eventually. If spinodal decomposition happens, a material property will change a lot, but this decomposition advances rapidly.

[0004] Therefore, since subsequent processing not only becomes easy, but material property dispersion will become small and quality will be stabilized, if an ingredient can be cooled before spinodal decomposition arises after performing hot-rolling and solution treatment, About the solution treatment of a titanium copper alloy, dispersion in characteristics is small and it is necessary for subsequent processing to process on the cooling conditions which become easy. Moreover, when

carrying out components processing after carrying out aging treatment of the titanium copper alloy, it is necessary to lessen anisotropy and to raise bending nature.

[0005]

[Problem(s) to be Solved by the Invention] However, since it was not grasped whether which factor of effect is conventionally the largest among the manufacturing process conditions exerted on anisotropy, as for bending nature, it was inadequate. According to investigation and an experiment of this invention persons, it became clear that the grain size number of the ingredient by solution treatment cooling conditions and solution treatment had affected the subsequent material property greatly. In view of the starting point, it succeeds in this invention, and it offers the copper alloy expansion material which lessened anisotropy and was excellent in the bending nature in the case of components processing.

[0006]

[Means for solving problem] The place made into the summary of this invention is as following.

(1) Roll titanium to the copper alloy which consists of copper as for which more than 0.5 mass % becomes a under 5.0 mass % implication and a remainder real target, and an inevitable impurity. Solution treatment and aging treatment are performed, it is manufactured, and the grain size number after the last solution treatment of more than 0.005 mm is under 0.035 mm. Copper alloy expansion material characterized by for there having been little anisotropy which has the tensile strength of 800Ns/mm² or more after aging treatment, and is expressed with the difference of the tensile strength of a rolling parallel direction and a rolling perpendicular direction in mm² and 30Ns /or less, and bending nature being excellent.

(2) Face performing rolling, solution treatment, and aging treatment to the copper alloy ingot which a under 5.0 mass % implication and the remainder become from copper and an inevitable impurity substantially about titanium in more than 0.5 mass %, and manufacturing expansion material. The manufacturing method of the copper alloy expansion material characterized by more than 0.005 mm making the grain size number after the last solution treatment of a copper alloy under into 0.035 mm.

(3) The manufacturing method of the copper alloy expansion material characterized by quenching with the cooling rate more than a 200K/second after cooking temperature heats the conditions of the last solution treatment 10 seconds or more under by 1123K (850 degrees C) more than 923K (650 degrees C) at less than 300 seconds, when continuation equipment performs solution treatment for the above-mentioned copper alloy.

[0007] Namely, [titanium] as mentioned above if the tensile strength after aging treatment is less than 800Ns/mm² in the copper alloy exhibition **** material as for which more than 0.5 mass % consists of a under 5.0 mass % implication, remainder copper, and an inevitable impurity If the anisotropy which hardness runs short and is expressed with the difference of the tensile strength of a rolling parallel direction and a rolling perpendicular direction exceeds two in 30Ns/mm Anisotropy became large and the anisotropy which has the tensile strength of 800Ns/mm² or more in ** in which bending nature is not excellent after aging treatment, and is expressed with the difference of the

tensile strength of a rolling parallel direction and a rolling perpendicular direction to it in this invention limited in mm² and 30Ns /or less. The isotropy of this outstanding expansion material and high intensity are not obtained by the conventional material, and this is related to the grain size number (grain size number after the last solution treatment) of a medium process. In addition, a final grain size number does not have serious effect on anisotropy, although it fluctuates somewhat to the grain size number of a medium process under the effect of treatment of a back process.

[0008] [that next, more than 0.5 mass % used titanium as the remainder real target with copper and an inevitable impurity in this invention under including 5.0 mass %] It is because outstanding characteristics, such as hardness, will not be acquired if the addition of titanium becomes under 0.5 mass %, and the ingredient where the ingredient hardened and which was excellent in workability will not be obtained if it becomes more than 5.0 mass %. In addition, in addition to titanium, the same effect is expectable even if it adds chromium below 1.0 mass %, zirconium, nickel, iron, etc. in a total amount. [that the grain size number after the last solution treatment of this copper alloy was 5 micrometers or more less than 35 micrometers] It is because the expansion material which the effect of pre-processings, such as cold working, remains, and has sufficient working characteristic when a grain size number becomes under 0.005 mm is not obtained, and is because anisotropy becomes large and bending nature is remarkably inferior, when carrying out components processing when this grain size number becomes more than 0.035 mm.

[0009] Moreover, when performing solution treatment using continuation heat treatment equipment, after cooking temperature heats the conditions of the last solution treatment 10 seconds or more under by 1123K (850 degrees C) more than 923K (650 degrees C) at less than 300 seconds, it is desirable to quench with the cooling rate more than a 200K/second. Control becomes difficult, in order to carry out grain growth promptly and to obtain the ingredient of the above-mentioned grain size number, if the above-mentioned grain size number is not obtained even heating for 300 seconds or more as cooking temperature is under 923K (650 degrees C), but the temperature is reached as it is more than 1123K (850 degrees C). Furthermore, when it cooled with the cooling rate of under the 200K/second, the cooling rate after solution treatment was carried out to more than the 200K/second, in order that spinodal decomposition might arise at the time of cooling and an ingredient might harden. In addition, it is obtained by cooling by water cooling or air-water spraying in order to attain the cooling rate more than a 200K/second.

[0010]

[Function] According to this invention, if more than 0.005 mm makes the grain size number after the last solution treatment of a titanium copper alloy under into 0.035 mm, anisotropy at the time of carrying out components processing will be lessened, and it will become possible to offer the ingredient which has the characteristics which were excellent in bending nature.

[0011]

[Working example] The component of the titanium copper alloy which did predetermined mass % inclusion of the titanium used as a test specimen is shown in Table 1. 3.5kg

(30mmtx120mmwx100mml) of ingots of the titanium copper alloy blended with the predetermined component are ingoted within a vacuum melting furnace, and surface peeling is performed after cutting a feeding head part. thickness (usually 8mm thickness) predetermined from 27mm thickness after the peeled ingot performs homogenizing annealing by 1123K (850 degrees C) in the air for 1 hour -- until -- it hot-rolls. During rolling, the degree of material-list surface temperature was measured with 2 color type radiation temperature plan, and it water-cooled in the place which became a predetermined temperature.

[0012]

[Table 1]

試験に用いたチタンを所定質量%含有した銅合金の成分

		成分 (wt%)	
		Ti	銅
1	チタン銅 ①	1.5	残
2	チタン銅 ②	3.0	残
3	チタン銅 ③	4.5	残
比較			
4	チタン銅 ④	0.4	残
5	チタン銅 ⑤	6.0	残

[0013] Although titanium copper ** which is a comparison alloy went to the last aging treatment, the characteristics (tensile-strength 800 N/mm², 2% or more of elongation) needed were not acquired. The crack generated titanium copper ** which is a comparison alloy on the occasion of hot-rolling, and subsequent processing became difficult.

[0014] Furthermore, after carrying out solution treatment by 1173K (900 degrees C) for 1 hour, surface hide shaving is performed again and it is made 1.0mm thickness from 7.5mm thickness with cold rolling. Next, predetermined time heating of heating and the cooling rate was carried out at a predetermined temperature using the equipment which can be changed arbitrarily, the last solution treatment cooled on various cooling conditions was performed, and it evaluated according to the grain size test method (JIS H0501) of a copper elongation article after that. Furthermore, it cold-rolled to 0.3mm of stock thickness, and aging treatment was performed by 673K (400 degrees C) for 4 hours. In addition, the material temperature under heat treatment equipped the heat treatment portion of the ingredient with the contact process thermocouple, and measured the material temperature under check continuously, and various cooling rates were performed by adjusting water cooling, sea-mingled-with-fresh-water spraying, the amount of water of air cooling, and a gas mass flow. Then, while doing the tensile test of parallel to rolling of an ingredient, and a perpendicular direction and investigating anisotropy, the bending test estimated bendability repeatedly.

[0015] The last heat treatment condition of a test specimen is shown in drawing 1 (Table 2).

Moreover, the test result which did the tensile test and the flex test is shown in drawing 2 (Table 3). A tensile test shows the average of N= 3. R= 0.3mm of bend radii estimated the 90-degree flex test by

the number of times to fracture (0.3mm of board thickness). "Fracture" in front was fractured by the 1st bending. Anisotropy was small and the method manufactured in this invention enabled it to manufacture this copper alloy excellent also in repeat bendability so that more clearly than Table 3. [0016]

[Effect of the Invention] According to this invention, anisotropy becomes it is small and possible [manufacturing this copper alloy that was excellent also in repeat bendability].

[Brief Description of the Drawings]

[Drawing 1] It is the graph (Table 2) showing the last heat treatment condition of a test specimen.

[Drawing 2] It is the graph (Table 3) showing the test result which did the tensile test and the flex test.

[Drawing 1]

表 2 供試材の最終熱処理条件

		加熱温度 K (°C)	加熱時間 (秒)	急冷時の冷却速度 (K/秒)	溶体化処理後の 結晶粒度(μm)
1	チタン銅 ①	1023(750)	20	1000	10
2	チタン銅 ①	973(700)	120	800	10
3	チタン銅 ②	1073(800)	100	1000	20
4	チタン銅 ②	1073(800)	15	1000	10
5	チタン銅 ②	1073(800)	120	1000	30
6	チタン銅 ②	1023(750)	30	800	10
7	チタン銅 ②	953(680)	250	800	10
8	チタン銅 ③	1073(800)	60	800	20
9	チタン銅 ③	1023(750)	100	1000	20
10	チタン銅 ③	953(680)	250	800	10
比較					
10	チタン銅 ①	873(600)	250	1000	5<
11	チタン銅 ②	893(620)	250	800	5<
13	チタン銅 ②	1173(900)	100	1000	40
14	チタン銅 ②	973(700)	10	1000	5<
15	チタン銅 ③	1073(800)	600	800	40

[Drawing 2]

表3 引張り試験及び繰り返し曲げ試験

		溶体化処理 後の結晶粒 度 (μm)	引張強さ (N/mm ²)		90° 繰り返し曲げ (回)	
			平行方向	垂直方向	平行方向	垂直方向
1	チタン銅 ①	10	870	890	3	2
2	チタン銅 ①	10	920	930	3	2
3	チタン銅 ②	20	900	910	4	3
4	チタン銅 ②	10	910	920	3	2
5	チタン銅 ②	30	880	900	4	4
6	チタン銅 ②	10	960	970	3	2
7	チタン銅 ②	10	920	940	3	2
8	チタン銅 ③	20	980	1000	3	2
9	チタン銅 ③	20	1000	1030	1	1
10	チタン銅 ③	10	1050	1070	1	1
比較						
10	チタン銅 ①	5<	920	970	1	破断
11	チタン銅 ②	5<	970	1030	1	破断
13	チタン銅 ②	40	880	920	2	破断
14	チタン銅 ②	5<	1000	1050	破断	破断
15	チタン銅 ③	40	950	1020	1	破断

[Translation done.]